

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	"20050230631"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:24
L2	16	("4940901" "4982096" "5122666"  "5545899" "5581084" "6072224"  "6252231" "6396043").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:24
L3	516	250/370.08.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:24
L4	1253	250/370.09.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:25
L5	922	250/370.11.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:25
L6	308	250/370.14.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:25
L7	569	250/366.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:25

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L8	635	250/367.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:25
L9	2306	250/338.1.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:25
L10	676	250/338.3.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:25
L11	6224	I3 or I4 or I5 or I6 or I7 or I8 or I9 or I10	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:25
L12	760	(substrate and absorb\$4 and reflect\$4) and L11	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:26
L13	29	semiconduct\$4 and support and glass and insulat\$4 and fill\$4 and elements and I12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:29
L15	57	(CT or (computer adj tomograph\$4)) and ("x-ray" or (x adj ray) or xray) and (sens\$4 same arrangement) and I11	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:29

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L16	9	l15 and (solder or pad\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:30
L17	2	l15 and (epoxy or resin or titanium) and (pin adj diode)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:30
L18	1359	kuhlmann.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:30
L19	130	(support and glass and insulat\$4 and fill\$4) and l11	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:31
L20	56	l19 and (pad or solder)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:31
L21	52	l20 and (absor\$6 or reflect\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:32
L26	1	((substrate or wafer) and ((detect\$4 or sens\$4) and region) and (auxiliary and continu\$7) and (insulat\$4 and region) and pads). clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:36

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L27	1	((substrate or wafer) and ((detect\$4 or sens\$4) same region) and (auxiliary same continu\$7) and (insulat\$4 same region) and pads).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:36
L28	1	((substrate or wafer) and ((detect\$4 or sens\$4) and region) and (auxiliary and continu\$7) and (insulat\$4 and region) and pads and (x adj ray)).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:37
L29	1	((substrate or wafer) and ((detect\$4 or sens\$4) and region) and (auxiliary and continu\$7) and (insulat\$4 and region) and pads and pin).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/09/18 11:37